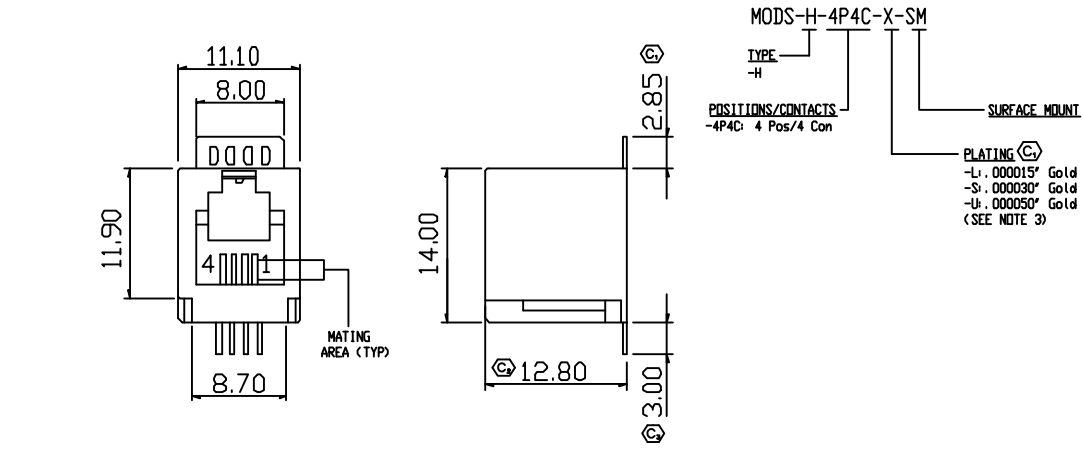


REVISION B



MODS-H-4P4C-X-SM

TYPE
-H


POSITIONS/CONTACTS
-4P4C: 4 Pos/4 Con

SURFACE MOUNT

PLATING (C)
-L: .000015" Gold
-S: .000030" Gold
-U: .000050" Gold
(SEE NOTE 3)

- NOTES:
1. Ⓢ REPRESENTS CRITICAL DIMENSION.
 2. CRITICAL DIMENSIONS ON PCB LAYOUT APPLY TO THE ASSEMBLY
 3. PLATING APPLIES TO MATING AREA, GOLD FLASH ON TAILS, ALL PLATING OVER Ni UNDERCOAT
 4. PIN NUMBERS REFLECT PIN CALLOUT ON THE CONNECTOR, NOT USER WIRING ASSIGNMENT.

PCB Layout

UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN MM. TOLERANCES ARE: DECIMALS .XX: ±.25 .XXX: ±.13 .XXXX: ±.05	PROPRIETARY NOTE THIS DOCUMENT CONTAINS INFORMATION CONFIDENTIAL AND PROPRIETARY TO SAMTEC INC. AND SHALL NOT BE REPRODUCED OR TRANSMITTED TO OTHER DOCUMENTS OR DISCLOSED TO OTHERS OR USED FOR ANY PURPOSE, OTHER THAN THAT FOR WHICH IT WAS ORIGINALLY INTENDED WITHOUT THE EXPRESS WRITTEN CONSENT OF SAMTEC INC.	 <p>520 PARK EAST BLVD. NEW ALBANY, IN 47150 (812) 944-6733 P.O. BOX 1147 TWC: 810-540-4085</p>	<p>DESCRIPTION: RJ11 Top Entry SMT PCB Jack</p> <p>DWG. NO. MODS-H-4P4C-X-SM</p> <p>BY: J. Riley 07/13/04 SHEET 1 OF 1</p>
DO NOT SCALE DRAWING INSULATING: 8pin 48 CONTACTS: 4pin Phone Brnch	<p>ANGLES 2</p> <p>SHEET SCALE: 1:2</p> <p>MAX FLASH ALLOWED: .081 MAX GATE VENTED: .081 F:\DWG\EXISPROD\SEMBLY\MODJACKS\MODS\</p>		